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1. Name of conveying party(ies):

Tetsuya SAWAHATA
Mitsugu SATO
Yoichi OSE

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

1-13-00

- ☒ Assignment ☐ Merger
☐ Security Agreement ☐ Change of Name
☐ Other _____

Execution Date: 24 December 1999

2. Name and address of receiving party(ies):

Name: HITACHI, LTD.

Internal Address:

Street Address: 6, Kanda Surugadai 4-chome
Chiyoda-ku, Tokyo 101, JAPAN

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or patent number(s);

09/462769

If this document is being filed together with a new application, the execution date of the application is: 24 December 1999:

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached: ☐ Yes ☒ No

5. Name and address of party to whom
correspondence concerning document should be
mailed:

John C. Altmiller
Kenyon & Kenyon
1500 K Street, N.W., Suite 700
Washington, DC 20005

6. Total number of applications
and patents involved: 1

7. Total fee (37 CFR 3.41).....\$40.00

- ☐ Enclosed
☒ Authorized to be charged to deposit account

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11-0600

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

John C. Altmiller
Name of Person Signing

Signature

13 January 2000
Date

Total number of pages including cover sheet, attachments, and document: 2

(讓 渡 証)

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by HITACHI, LTD., a corporation organized under the laws of Japan, located at 6, Kanda Surugadai 4-chome, Chiyoda-ku, Tokyo, Japan, receipt of which is hereby acknowledged I do hereby sell and assign to said HITACHI, LTD., its successors and assigns, all my right, title and interest, in and for the United States of America, in and to

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said HITACHI, LTD., its successors, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said HITACHI, LTD.

(署名日)

1)	Tetsuya Sawakata	12/24/1999
2)	Mitsugu Sato	12/24/1999
3)	Naoki C. re	12/24/1999
4)		
5)		
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10)		

PATENT
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